



**CONTINUATION-IN-PART PATENT APPLICATION TRANSMITTAL**  
(37 C.F.R. § 1.53(b))



Attorney Docket No.: BDG005-6

Inventor: Cheng-Lien Chiang of Taipei, Taiwan

Title: THREE-DIMENSIONAL STACKED SEMICONDUCTOR PACKAGE DEVICE  
WITH BENT AND FLAT LEADS

Prior Group Art Unit: 2815

Prior Examiner: S. Clark

**Mail Stop Patent Application**  
**Commissioner for Patents**  
**P.O. Box 1450**  
**Alexandria, VA 22313-1450**

This is a CONTINUATION-IN-PART application of pending prior U.S. Application Serial No. 10/137,494, filed April 30, 2002, which is a continuation-in-part of U.S. Application Serial No. 10/042,812, filed January 9, 2002.

This is a CONTINUATION-IN-PART application of pending prior U.S. Application Serial No. 10/136,954, filed April 30, 2002, which is a continuation-in-part of U.S. Application Serial No. 10/042,812, filed January 9, 2002.

Enclosed for filing with the above-identified utility patent application, please find the following:

1. [X] Application, consisting of
  - Specification (49 pages)
  - Claims (23 pages)
  - Abstract (1 page)
  - Drawings (37 sheets) (formal)
2. [X] Declaration
3. [X] Assignment Papers (*Cover Sheet & Assignment*)
4. [X] Power of Attorney
5. [X] Statement under 37 C.F.R. § 3.73(b) Establishing Right of Assignee to Take Action
6. [X] Information Disclosure Statement (IDS/PTO-1449)
7. [X] Statement Claiming Small Entity Status by Small Business Concern
8. [X] Request for Nonpublication of Application
9. [X] Return Postcard (MPEP 503) (*specifically itemized*)

**FEE CALCULATION:**

	(COL. 1) NO. FILED			(COL. 2) NO. EXTRA	SMALL ENTITY	
					RATE	FEE
BASIC FEE:						\$385
TOTAL CLAIMS:	100	-	20	80	X \$9 =	\$720
INDEP. CLAIMS:	10	-	3	7	X \$43 =	\$301
MULTIPLE DEPENDENT CLAIMS: 0					+\$140 =	\$0
TOTAL FILING FEE						\$1406

**OTHER INFORMATION:**

1. Charge the \$1406 to Deposit Account No. 502178/BDG005-6 and charge any underpayment or credit any overpayment to this Account..
2. The application is assigned to Bridge Semiconductor Corporation.
3. Correspondence Address:

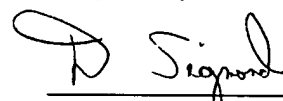
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ADDRESSEE: MAIL STOP PATENT APPLICATION  
COMMISSIONER FOR PATENTS  
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Respectfully submitted,



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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Cheng-Lien Chiang  
Assignee: Bridge Semiconductor Corporation  
Title: THREE-DIMENSIONAL STACKED SEMICONDUCTOR  
PACKAGE DEVICE WITH BENT AND FLAT LEADS  
Serial No.: Unknown Filed: Herewith  
Examiner: Unknown Group Art Unit: Unknown  
Atty. Docket No.: BDG005-6

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COMMISSIONER FOR PATENTS  
P.O. Box 1450  
Alexandria, VA 22313-1450

**REQUEST FOR NONPUBLICATION OF APPLICATION**

Applicant requests that the above-identified application not be published under 35 U.S.C. § 122(b).

Applicant certifies that the invention disclosed in this application has not been and will not be the subject of an application filed in another country, or under a multilateral international agreement, that requires publication at eighteen months after filing.

This request is being submitted with this application on filing.

Respectfully submitted,



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